

Electronic Patent Application Fee Transmittal

Application Number:	10506478			
Filing Date:	01-Sep-2004			
Title of Invention:	METHOD FOR DRY ETCHING A SEMICONDUCTOR WAFER			
First Named Inventor:	Hyo Sang Kang			
Filer:	Aaron Richard Wininger			
Attorney Docket Number:	61282.00016			
Filed as Small Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	2501	1	700	700
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1000